

STW30NM60D

N-channel 600V - 0.125Ω - 30A - TO-247 Fast diode MDmesh™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STW30NM60D	600V	< 0.145Ω	30A

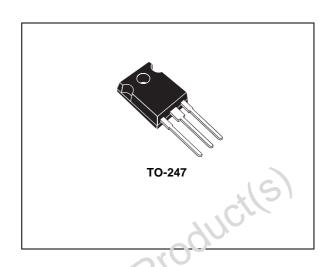
- High dv/dt and avalanche capabilities
- 100% avalanche rated
- Low input capacitance and gate charge
- Low gate input resistance
- Fast internal recovery diode

Description

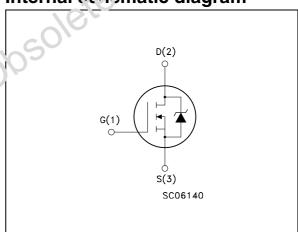
The FDmesh™ associates all advantages of reduced on-resistance and fast switching with an intrinsic fast-recovery body diode. It is therefore strongly recommended for bridge topologies, in particular ZVS phase-shift converters.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STW30NM60D	W30NM60D	TO-247	Tube

Contents STW30NM60D

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STW30NM60D Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	600	V
V_{DGR}	Drain-gate voltage ($R_{GS} = 20kΩ$)	600	V
V _{GS}	Gate- source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25°C	30	Α
I _D	Drain current (continuous) at T _C = 100°C	18.9	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	120	Α
P _{TOT}	Total dissipation at T _C = 25°C	312	W
	Derating factor	2.5	W/°C
dv/dt (2)	Peak diode recovery voltage slope	20	V/ns
T _j T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	0.4	°C/W
Rthj-amb	Thermal resistance junction-ambient max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
lar	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	15	А
E _{AS}	Single pulse avalanche energy (starting $T_j = 25^{\circ}C$, $I_D = I_{AR}$, $V_{DD} = 50V$)	740	mJ

^{2.} $I_{SD} \le 30A$, di/dt $\le 400A/\mu s$, $V_{DD} = 80\%V_{(BR)DSS}$

Electrical characteristics STW30NM60D

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0	600			٧
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, @125°C			10 100	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			± 10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on}	Static drain-source on resistance	V _{GS} = 10V, I _D = 15A		0.125	0.145	Ω

Table 5. Dynamic

Obsolete 1

Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V , I _D = 15A		16		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1MHz,$ $V_{GS} = 0$		2520 800 75		pF pF pF
Coss eq. (2)	Equivalent output capacitance	$V_{GS} = 0V, V_{DS} = 0 \text{ to } 480V$		390		pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 480V$, $I_D = 30A$, $V_{GS} = 10V$ Figure 15		82 24 42	115	nC nC nC

^{1.} Pulsed: Pulse duration = 300µs, duty cycle 1.5 %

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Switching on/off (inductive load) Table 6.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off-delay time Fall time	$V_{DD} = 300V, I_{D} = 15A,$ $R_{G} = 4.7\Omega, V_{GS} = 10V$ Figure 14		32 33 75 35		ns ns ns ns

Table 7. Source drain diode

	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	I _{SD}	Source-drain current				30	Α
	I _{SDM} (1)	Source-drain current (pulsed)				120	Α
	V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 30A, V_{GS} = 0$			1.5	V
	t _{rr}	Reverse recovery time	$I_{SD} = 30A$, di/dt=100A/ μ s		165		ns
	Q _{rr}	Reverse recovery charge Reverse recovery current	V _{DD} = 50V,Tj=25°C <i>Figure 17</i>		1.1 14	15	nC A
	I _{RRM}	Ith limited by safe operating area.	rigure 17		17		
		our illinited by sale operating area. Pulse duration = 300µs, duty cycle 1.5	Figure 17 %		70,		
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Electrical characteristics STW30NM60D

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

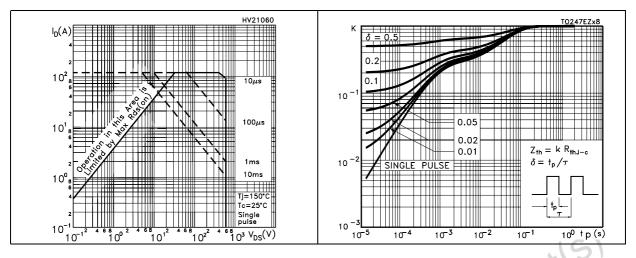


Figure 3. Output characterisics

Figure 4. Transfer characteristics

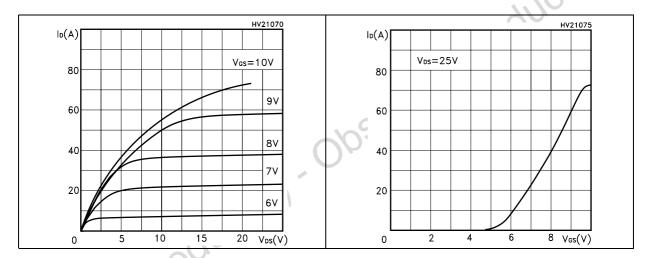


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

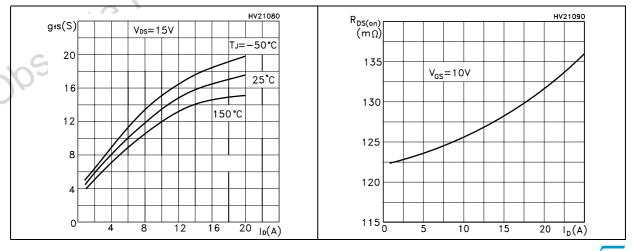


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

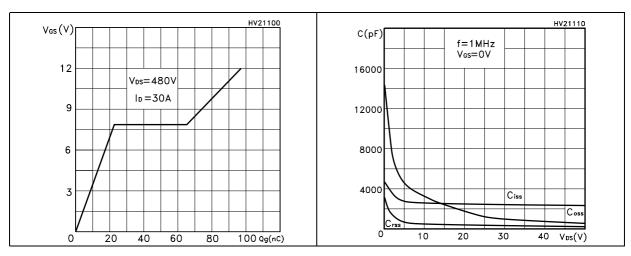


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

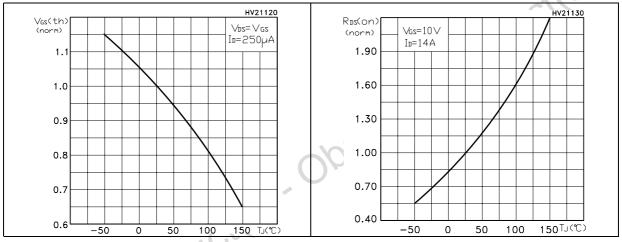
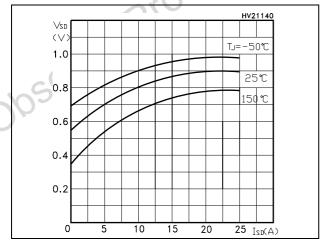


Figure 11. Source-drain diode forward characteristics



Test circuit STW30NM60D

3 Test circuit

Figure 12. Unclamped inductive load test circuit

Figure 13. Unclamped inductive wafeform

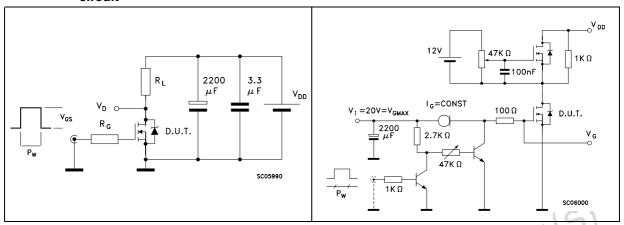


Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

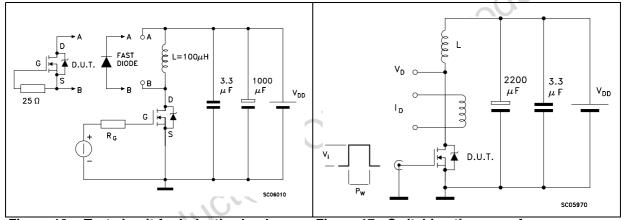
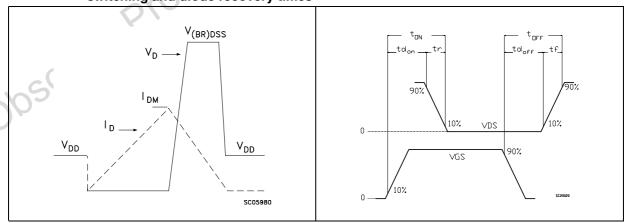


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Switching time waveform



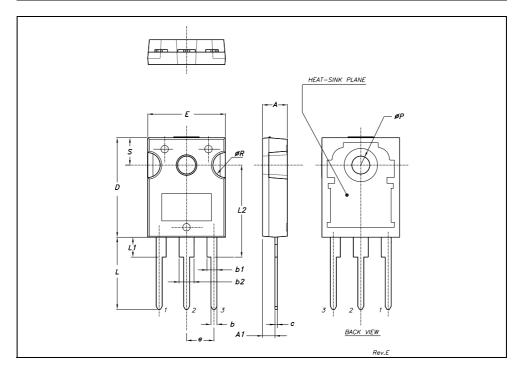
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

TO-247 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
Е	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



Obsole

STW30NM60D Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes
24-June-2004	1	The document change from "ADVANCED" to "COMPLETE". New stylesheet. Rds(on) Max@10V changed. See Table 4.
06-Dec-2005	2	Inserted ecopack indication
20-Dec-2005	3	Modified value on Source drain diode
24-Jan-2006	4	Changed unit on <i>Dynamic</i>
13-Jul-2006	5	New template, modified unit on Source drain diode

Obsolete Product(s).

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